

Features

- High speed 1MBit/s
- High isolation voltage between input and output (Viso=5000 Vrms)
- Guaranteed CTR performance from 0°C to 70°C
- Wide operating temperature range of -55°C to 100°C
- Regulatory Approvals
 - UL UL1577 (E364000)
 - VDE EN60747-5-5(VDE0884-5)
 - CQC GB4943.1, GB8898
 - IEC60065, IEC60950

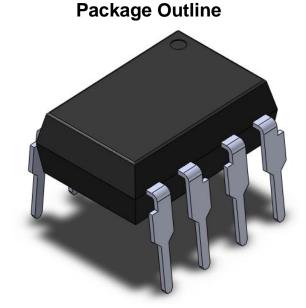
Applications

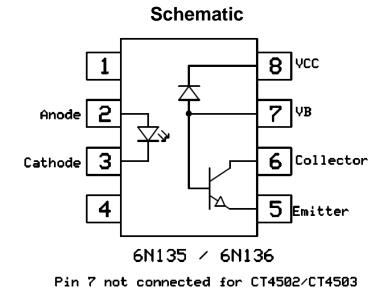
- Line receivers
- Telecommunication equipment
- High speed logic ground isolation
- Feedback loop in switch-mode power supplies
- Home appliances

Description

The 6N135, 6N136, CT4502 and CT4503 devices each consist of an infrared emitting diode, optically coupled to a high speed photo detector transistor. A separate connection for the photodiode bias and output-transistor collector increase the speed by several orders of magnitude over conventional phototransistor couplers by reducing the base-collector capacitance of the input transistor.

The devices are packaged in an 8-pin DIP package and also available in gullwing (400mil) and surface mount lead forming.





Note: Different bending options available. See package

dimension.



Absolute Maximum Rating at 25°C

Symbol	Parameters	Ratings	Units	Notes
Viso	Isolation voltage	5000	VRMS	1
Topr	Operating temperature	-55 ~ +100	°C	
Tstg	Storage temperature	-55 ~ +125	°C	
Tsol	Soldering temperature	260	°C	2
Emitter				
lF	Forward current	25	mA	
I FP	Peak forward current (50% duty, 1ms P.W)	50	mA	
I _{F(TRANS)}	Peak transient current (≤1µs P.W,300pps)	1	А	
VR	Reverse voltage	5	V	
PD	Power dissipation	40	mW	
Detector				
PD	Power dissipation	100	mW	
Vebr	Emitter-Base reverse voltage	5	V	
IB	Base current	5	mA	
IO(AVG)	Average Output current	8	mA	
I _{O (Peak)}	Peak Output current	16	mA	
Vo	Output voltage	-0.5 to 20	V	
Vcc	Supply voltage	-0.5 to 30	V	

Notes

1. AC for 1 minute, $RH = 40 \sim 60\%$.

2. For 10 second peak



Electrical Characteristics

 $T_A = 0 - 70^{\circ}C$ (unless otherwise specified). Typical values are measured at $T_A = 25^{\circ}C$ and $V_{CC}=5V$

Emitter Characteristics

Symbol	Parameters	Test Conditions	Min	Тур	Max	Units	Notes
VF	Forward voltage	IF = 16mA	-	1.45	1.6	V	
VR	Reverse Voltage	IR = 10µA	5.0	-	-	V	
Δν _γ /Δτ _α	Temperature coefficient of forward voltage	IF =16mA	-	-1.8	-	mV/°C	

Detector Characteristics

Symbol	Parameters	Test Conditions	Min	Тур	Max	Units	Notes
	Logic High Output Current	IF=0mA, Vo=Vcc=5.5V,		0.001	0.5	μA	
		T _A =25°C	-				
Іон		IF=0mA, Vo=Vcc=15V,		0.01	1		
		T _A =25°C	-				
		$I_F=0mA$, $V_O=V_{CC}=15V$	-	-	50		
laai	Logic Low Supply Current	I⊧=16mA, V₀=Open,	-	140	200	μΑ	
ICCL		V _{CC} =15V					
	Logic High Supply Current	$I_F=0mA$, $V_O=Open$, $V_{CC}=15V$,		0.01	1	- μΑ	
1		T _A =25°C	-				
Іссн		IF=0mA, VO=Open,			2		
		VCC=15V	-				



Electrical Characteristics

 $T_A = 0 - 70^{\circ}C$ (unless otherwise specified). Typical values are measured at $T_A = 25^{\circ}C$ and $V_{CC}=5V$

Transfer Characteristics

Symbol	Paramete	ers	Test Conditions	Min	Тур	Max	Units	Notes
	6N136 CT450 Current Transfer CT450 Ratio 6N136 6N136 CT450	6N135		7	-	50		
		6N136 CT4502 CT4503	IF=16mA, Vo=0.4V,Vcc=4.5V, T _A =25°C	19	-	50		
CTR		6N135		5	-	-	%	
		6N136 CT4502 CT4503	I _F =16mA, V ₀ =0.5V, V _{CC} =4.5V	15	-	-		
	6N1 CT2 Logic Low Output CT2 Voltage 6N1 6N1 CT2	6N135	I _F =16mA,I _O =1.1mA,V _{CC} =4.5V, T _A =25°C	-	0.18	0.4		
V		6N136 CT4502 CT4503	IF=16mA, Io=3mA, Vcc=4.5V, T _A =25°C	-	0.18	0.4	- V	
Vol		6N135	I _F =16mA, I _O =0.8mA, V _{CC} =4.5V	-	-	0.5		
		6N136 CT4502 CT4503	I _F =16mA, Io=2.4mA, V _{CC} =4.5V	-	-	0.5		



Electrical Characteristics

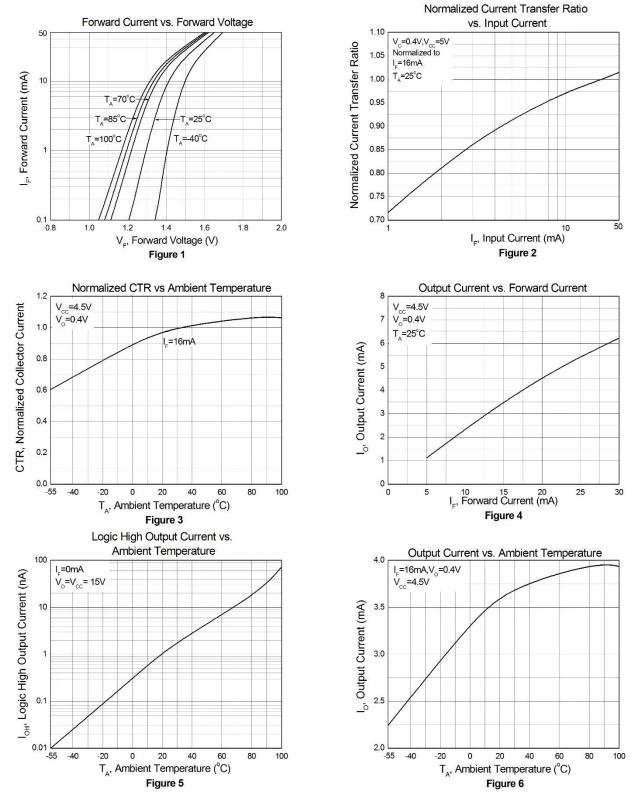
 $T_A = 0 - 70^{\circ}C$ (unless otherwise specified). Typical values are measured at $T_A = 25^{\circ}C$ and $V_{CC}=5V$

Switching Characteristics

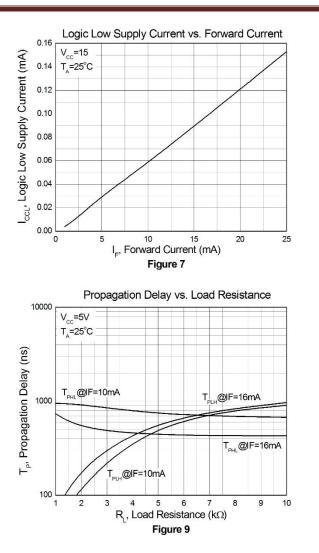
Symbol	Paramete	ers	Test Conditions	Min	Тур	Max	Units	Notes
	Propagation Delay Time Logic High to Logic Low	6N135	R _L =4.1KΩ, T _{A=} 25°C	-	0.35	1.5	_	
		00135	R _L =4.1KΩ	-	-	2.0		
T_{PHL}		6N136	R _L =1.9KΩ, T _A =25°C	-	0.35	0.8	μs	
		CT4502 CT4503	RL=1.9KΩ	-	-	1.0		
	Draw and the Dalay	01405	R _L =4.1KΩ, T _{A=} 25°C	-	0.5	1.5	_	
	Propagation Delay	6N135	R _L =4.1KΩ	-	-	2.0		
T _{PLH}	Time Logic Low to Logic High	6N136	R _L =1.9KΩ, T _A =25°C	-	0.3	0.8	μs	
		CT4502 CT4503	RL=1.9KΩ	-	-	1.0		
	Common Mode Transient Immunity at Logic High	6N135	$I_{F} = 0mA , V_{CM}=10Vp-p,$ $R_{L}=4.1K\Omega, T_{A}=25^{\circ}C$	1,000	-	-		
СМн		6N136 CT4502	$I_{F} = 0mA , V_{CM}=10Vp-p,$ $R_{L}=1.9K\Omega, T_{A}=25^{\circ}C$	1,000	-	-	V/µs	
		CT4503	$I_F = 0mA , V_{CM}=1500Vp-p,$ $R_L=1.9K\Omega, T_A=25^{\circ}C$	15,000	20,000			
CM∟	Common Mode Transient Immunity	6N135	$I_{F} = 16mA , V_{CM}=10Vp-p,$ $R_{L}=4.1K\Omega, T_{A}=25^{\circ}C$	1,000	-	-		
		6N136	Iғ = 16mA , V _{СМ} =10Vp-p,	1,000	-	-	V/µs	
	at Logic Low	CT4502	R _L =1.9KΩ, T _A =25°C					
		CT4503	$I_{F} = 16 \text{mA} , V_{CM} = 1500 \text{Vp-p},$ $R_{L} = 1.9 \text{K}\Omega, T_{A} = 25^{\circ}\text{C}$	15,000	20,000			

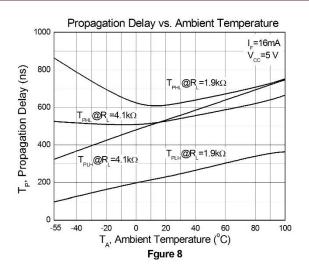


Typical Characteristic Curves



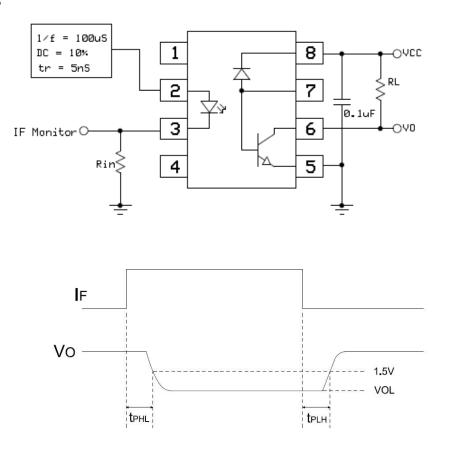








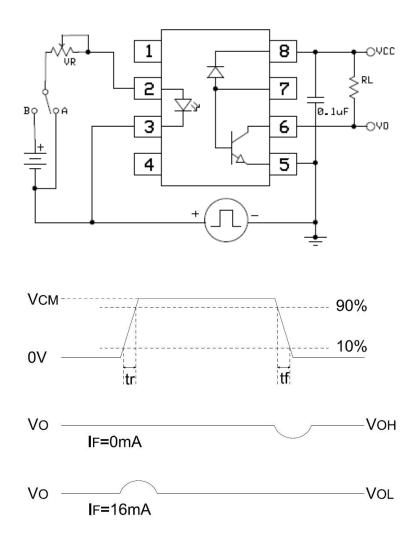
Test Circuits



Switching Time Test Circuit



Test Circuits

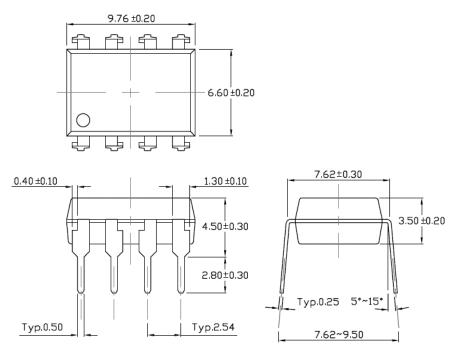


CMR Test Circuit

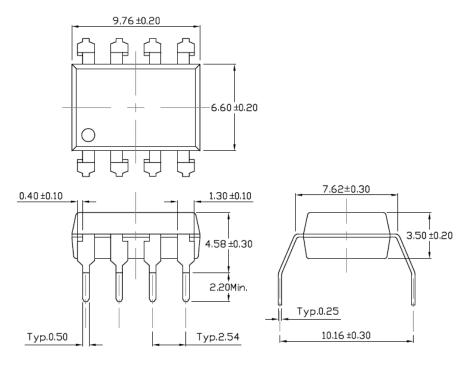


Package Dimension Dimensions in mm unless otherwise stated

Standard DIP – Through Hole

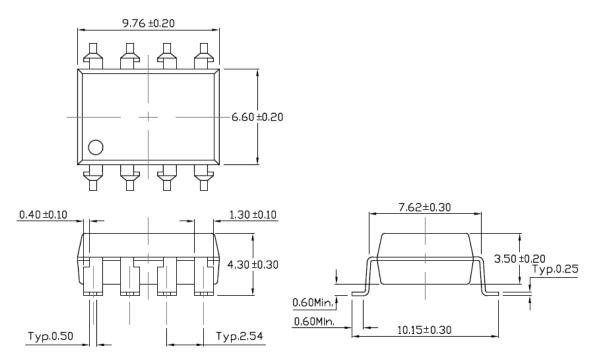


Gullwing (400mil) Lead Forming – Through Hole (M Type)

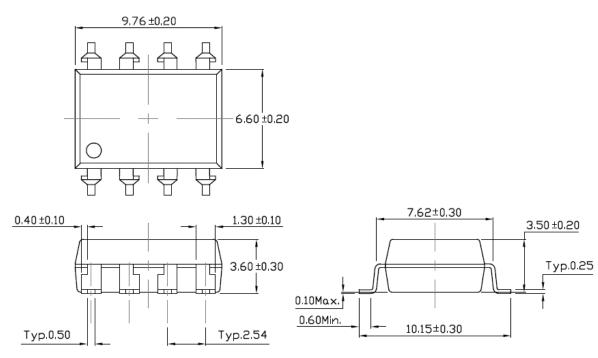




Surface Mount Lead Forming (S Type)

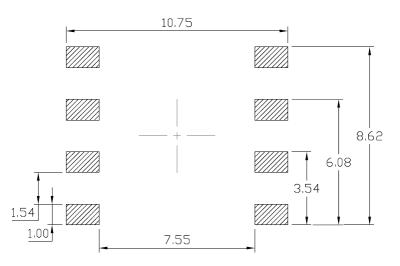


Surface Mount (Low Profile) Lead Forming (SL Type)

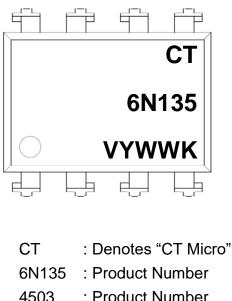


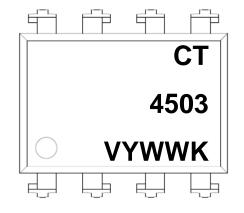


Recommended Solder Mask Dimensions in mm unless otherwise stated



Device Marking





CI	: Denotes "CT Micro"
6N135	: Product Number
4503	: Product Number
V	: VDE Option
Y	: Fiscal Year
WW	: Work Week

K : Production Code



Ordering Information

6N13X(V)(Y)(Z) or CT450X(V)(Y)(Z)

X = Part No. (5,6 for 6N13X series), (2,3 for CT450X series)

V = VDE Option (V or None)

Y = Lead form option (S, SL, M or none)

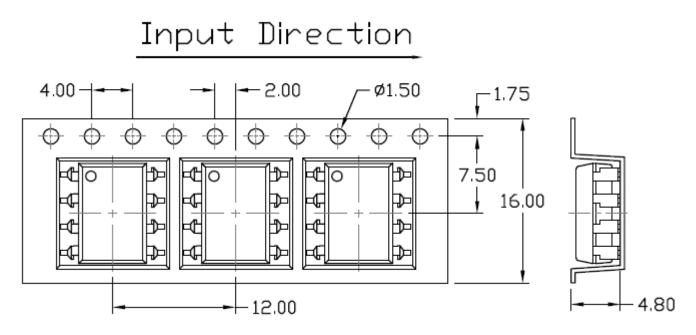
Z = Tape and reel option (T1, T2 or none)

Option	Option Description	
None	Standard 8 Pin Dip	40 Units/Tube
М	Gullwing (400mil) Lead Forming	40 Units/Tube
S(T1)	Surface Mount Lead Forming – With Option 1 Taping	1000 Units/Reel
S(T2)	Surface Mount Lead Forming – With Option 2 Taping	1000 Units/Reel
SL(T1)	Surface Mount (Low Profile) Lead Forming– With Option 1 Taping	1000 Units/Reel
SL(T2)	Surface Mount (Low Profile) Lead Forming– With Option 2 Taping	1000 Units/Reel

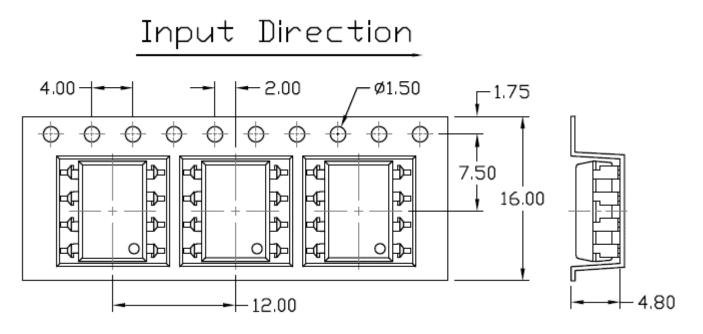


Carrier Tape Specifications Dimensions in mm unless otherwise stated

Option S(T1) & SL(T1)



Option S(T2) & SL(T2)





Wave soldering (follow the JEDEC standard JESD22-A111)

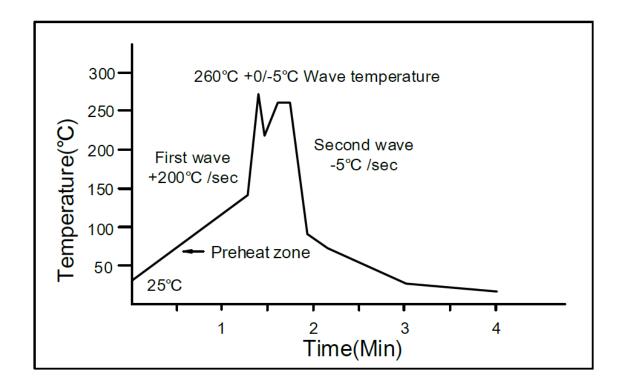
One time soldering is recommended within the condition of temperature.

Temperature: 260+0/-5°C.

Time: 10 sec.

Preheat temperature:25 to 140°C.

Preheat time: 30 to 80 sec.

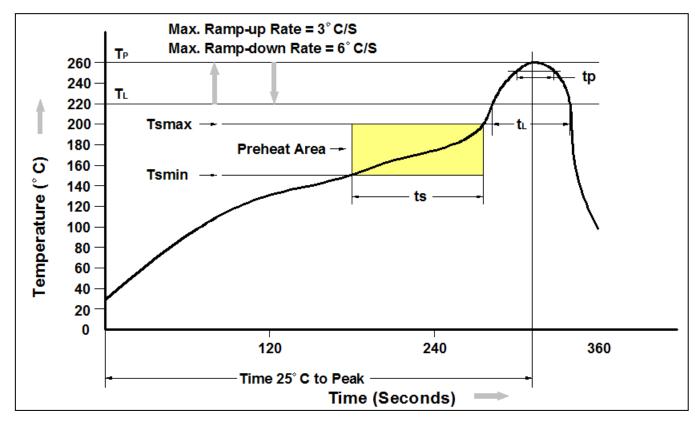


Iron soldering (follow the standard MIL-STD 202G, Method 210F)

Allow single lead soldering in every single process. One time soldering is recommended. Temperature: 350+±10°C Time: 5 sec max.



Reflow Profile



Profile Feature	Pb-Free Assembly Profile
Temperature Min. (Tsmin)	150°C
Temperature Max. (Tsmax)	200°C
Time (ts) from (Tsmin to Tsmax)	60-120 seconds
Ramp-up Rate (t∟ to t _P)	3°C/second max.
Liquidous Temperature (TL)	217°C
Time (t _L) Maintained Above (T _L)	60 – 150 seconds
Peak Body Package Temperature	260°C +0°C / -5°C
Time (t _P) within 5°C of 260°C	30 seconds
Ramp-down Rate $(T_P \text{ to } T_L)$	6°C/second max
Time 25°C to Peak Temperature	8 minutes max.



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